

Complementary MOSFET

ELM35601KA-S

■General Description

ELM35601KA-S uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■Features

N-channel	P-channel
• $V_{ds}=40V$	$V_{ds}=-40V$
• $I_d=7A$	$I_d=-5.5A$
• $R_{ds(on)} < 28m\Omega(V_{gs}=10V)$	$R_{ds(on)} < 48m\Omega(V_{gs}=-10V)$
• $R_{ds(on)} < 49m\Omega(V_{gs}=5V)$	$R_{ds(on)} < 85m\Omega(V_{gs}=-5V)$

■Maximum Absolute Ratings

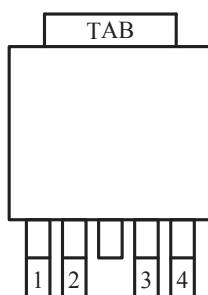
Parameter	Symbol	N-ch (Max.)	P-ch (Max.)	Unit	Note
Drain-source voltage	V_{ds}	40	-40	V	
Gate-source voltage	V_{gs}	± 20	± 20	V	
Continuous drain current	I_d	7.0	-5.5	A	
		6.0	-4.5		
Pulsed drain current	I_{dm}	50	-50	A	3
Power dissipation	P_d	3.0	3.0	W	
		2.1	2.1		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	-55 to 150	°C	

■Thermal Characteristics

Parameter	Symbol	Device	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	N-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	N-ch		6	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$	P-ch		42	°C/W	
Maximum junction-to-case	$R_{\theta jc}$	P-ch		6	°C/W	

■Pin configuration

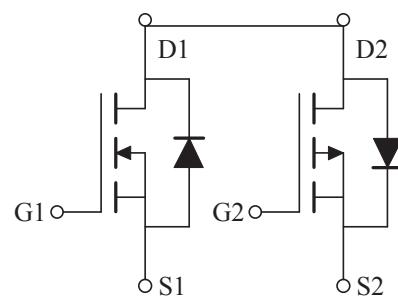
TO-252-4(TOP VIEW)



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	SOURCE2
4	GATE2
TAB	DRAIN1/DRAIN2

■Circuit

- N-ch
- P-ch



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■Electrical Characteristics (N-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250μA, Vgs=0V	40			V	
Zero gate voltage drain current	Idss	Vds=32V, Vgs=0V			1	μA	
		Vds=30V, Vgs=0V, Tj=55°C			10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250μA	1.2	2.0	3.0	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	50			A	1
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=7A		24	28	mΩ	1
		Vgs=5V, Id=6A		38	49		
Forward transconductance	Gfs	Vds=10V, Id=7A		19		S	1
Diode forward voltage	Vsd	If=7A, Vgs=0V			1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		530	662	pF	
Output capacitance	Coss			118	165	pF	
Reverse transfer capacitance	Crss			44	66	pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=10V, Vds=20V, Id=7A		12.8		nC	2
Gate-source charge	Qgs			2.0		nC	2
Gate-drain charge	Qgd			1.7		nC	2
Turn-on delay time	td(on)	Vgs=10V, Vds=20V, Id≈1A Rgen=6Ω		1.8	3.5	ns	2
Turn-on rise time	tr			6.0	12.0	ns	2
Turn-off delay time	td(off)			8.2	15.1	ns	2
Turn-off fall time	tf			3.0	5.9	ns	2
Body diode reverse recovery time	trr	If=8A, dl/dt=100A/μs		42		ns	
Body diode reverse recovery charge	Qrr			30		nC	

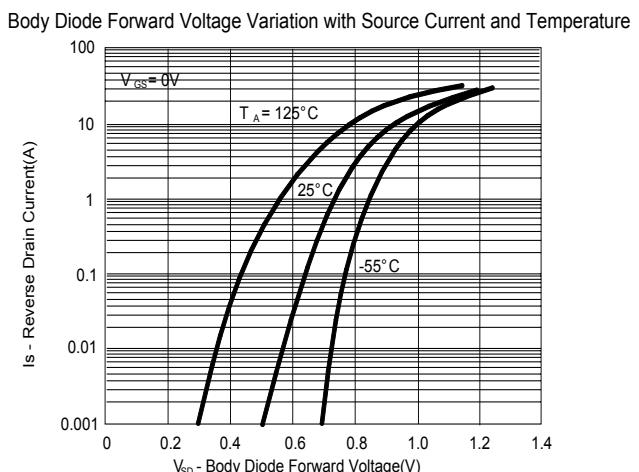
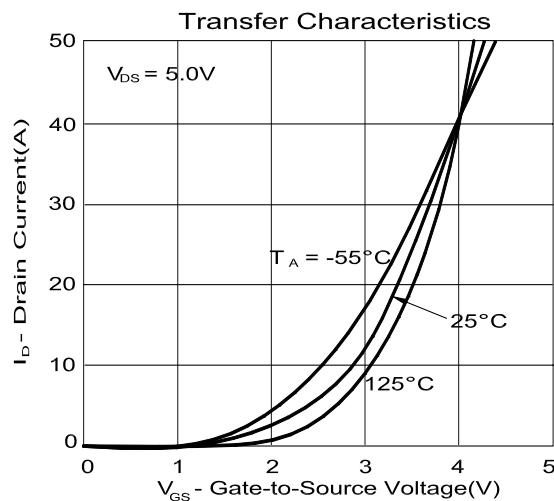
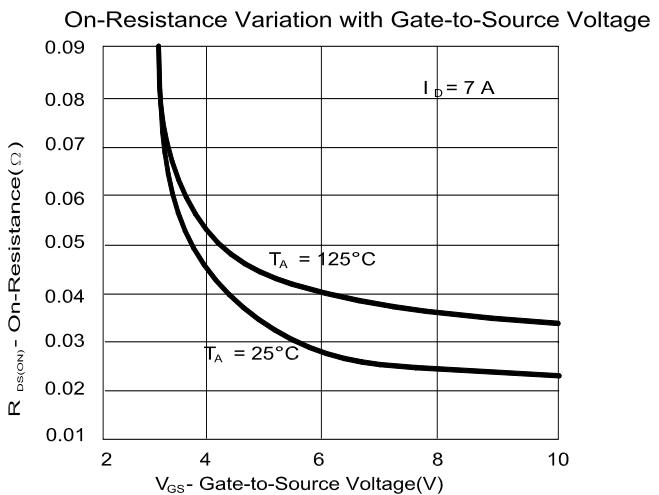
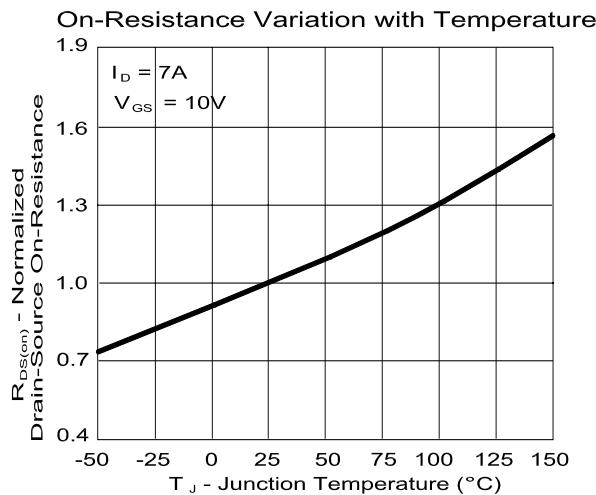
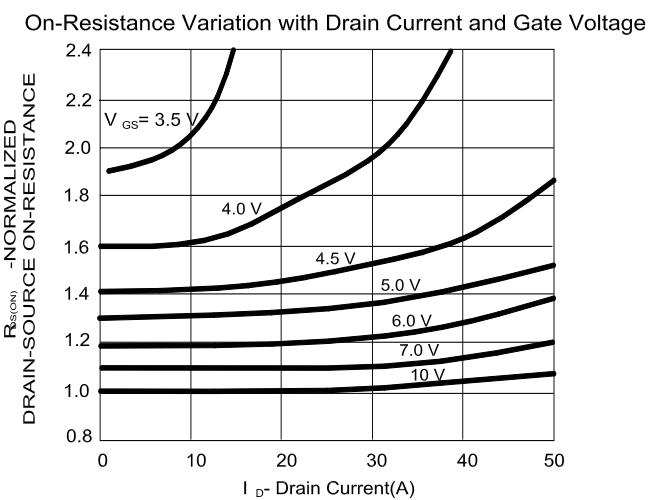
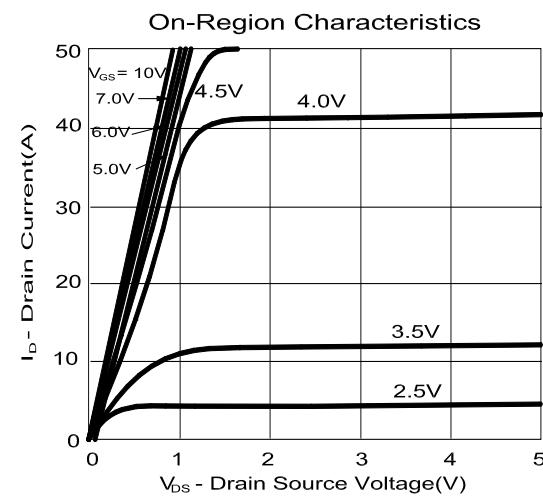
NOTE :

1. Pulse test : Pulsed width≤300μsec and Duty cycle≤2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.
4. Duty cycle ≤ 1%.

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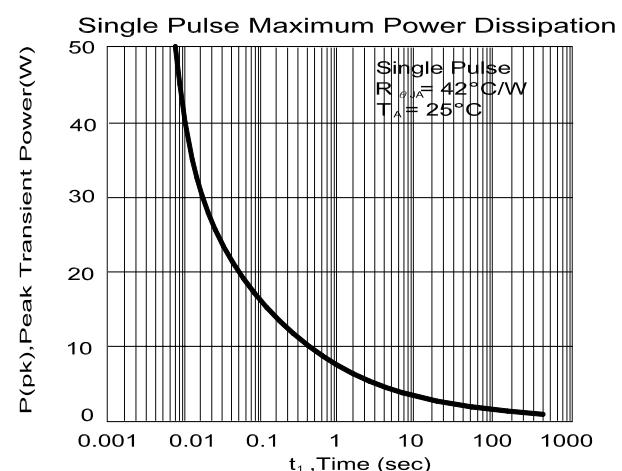
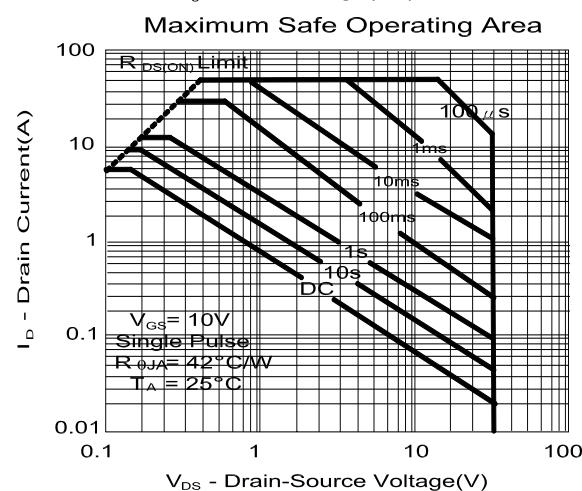
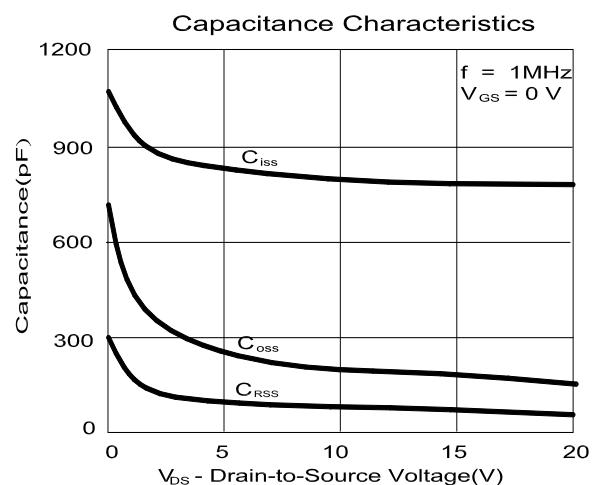
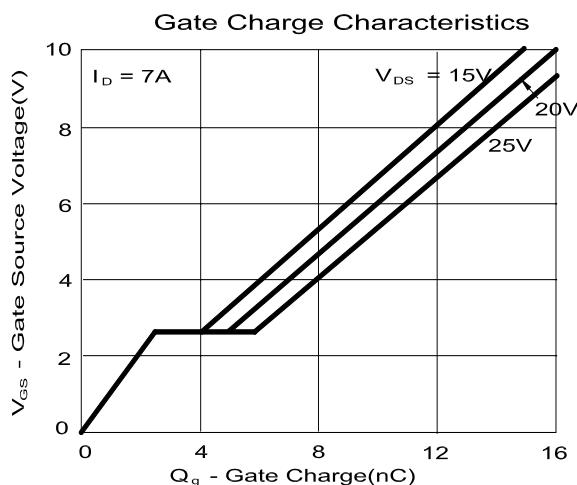
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■ Typical Electrical and Thermal Characteristics (N-ch)



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Complementary MOSFET

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■Electrical Characteristics (P-ch)

T_a=25°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	Id=-250μA, V _{gs} =0V	-40			V	
Zero gate voltage drain current	Id _{ss}	V _{ds} =-32V, V _{gs} =0V			-1	μA	
		V _{ds} =-30V, V _{gs} =0V, T _j =55°C			-10		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , Id=-250μA	-1.2	-2.0	-3.0	V	
On state drain current	Id(on)	V _{gs} =-10V, V _{ds} =-5V	-50			A	1
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V, Id=-5.5A		37	48	mΩ	1
		V _{gs} =-5V, Id=-4.5A		56	85		
Forward transconductance	G _{fs}	V _{ds} =-10V, Id=-5.5A		11		S	1
Diode forward voltage	V _{sd}	If=-5.5A, V _{gs} =0V			-1.2	V	1
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-10V, f=1MHz		690	863	pF	
Output capacitance	C _{oss}			310	430	pF	
Reverse transfer capacitance	C _{rss}			75	113	pF	
SWITCHING PARAMETERS							
Total gate charge	Q _g	V _{gs} =-10V, V _{ds} =-20V Id=-5.5A		14.0		nC	2
Gate-source charge	Q _{gs}			2.2		nC	2
Gate-drain charge	Q _{gd}			1.9		nC	2
Turn-on delay time	t _{d(on)}	V _{gs} =-10V, V _{ds} =-20V Id≈-1A, R _{gen} =6Ω		6.7	13.4	ns	2
Turn-on rise time	t _r			9.7	19.4	ns	2
Turn-off delay time	t _{d(off)}			19.8	35.6	ns	2
Turn-off fall time	t _f			12.3	22.2	ns	2
Body diode reverse recovery time	t _{rr}	If=-7A, dI/dt=100A/μs		55		ns	
Body diode reverse recovery charge	Q _{rr}			52		nC	

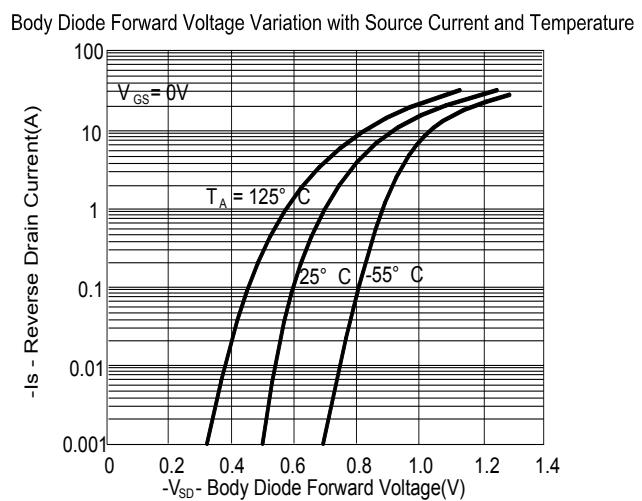
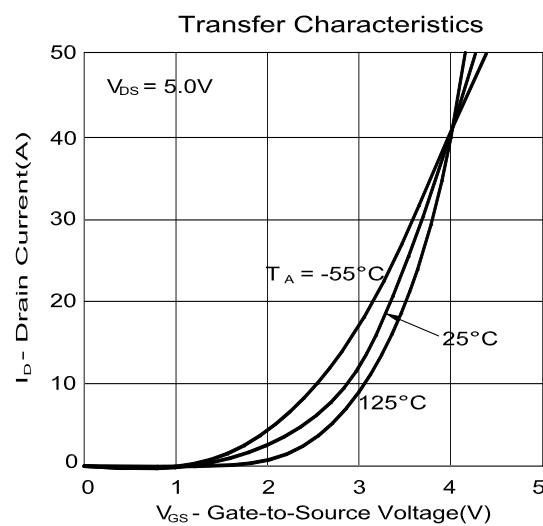
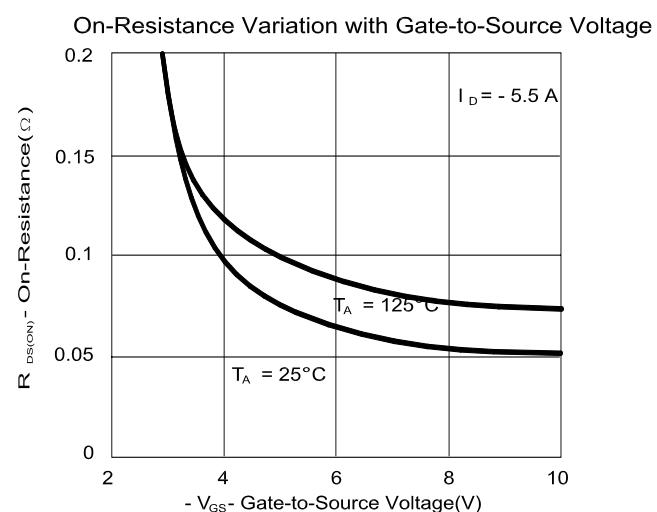
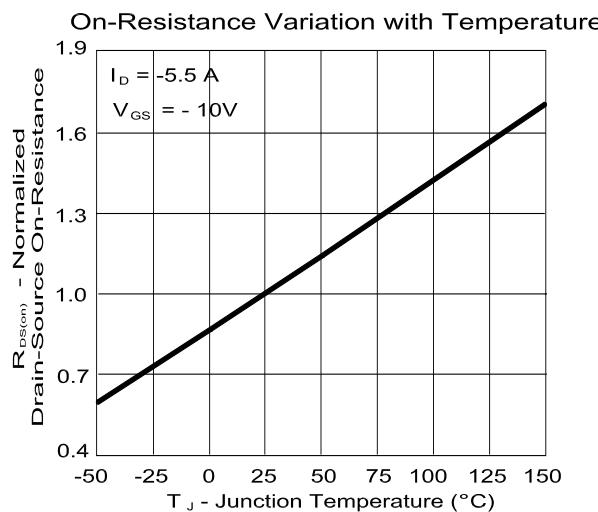
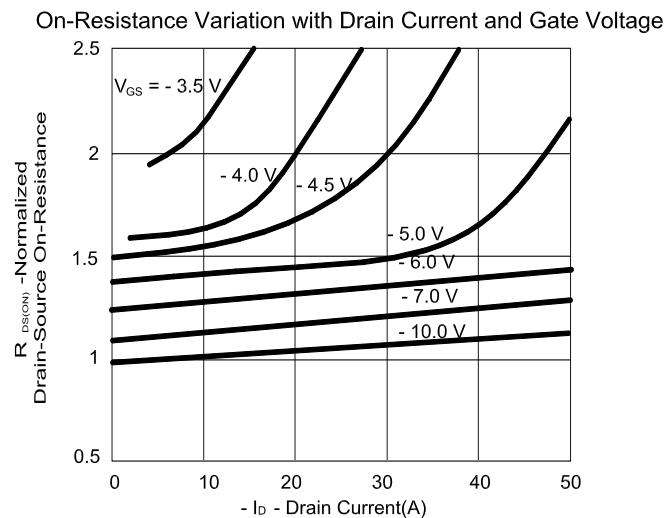
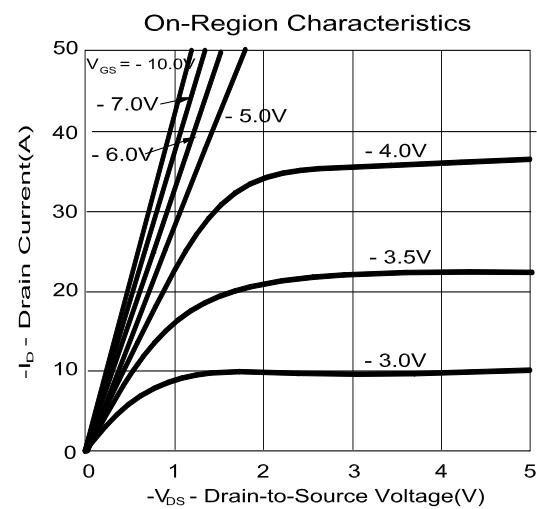
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